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Synthesis and thermal conductivity improvement of W-Cu composites modified with WC interfacial layer

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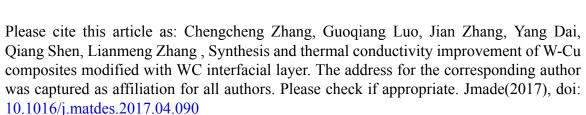
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